Deposition of carbon nanotubes in microwave torch and their application

Lenka Zajíčková

Department of Physical Electronics, Masaryk University, Brno, Czech Republic





http://www.physics.muni.cz/kfe

e-mail: lenkaz@physics.muni.cz

department profile: plasma processing of materials (PECVD, plasma treatment, PVD), plasma physics, hard films, plasma polymers, CNTs, Fe-based nanoparticles, characterization of thin films





Carbon Nanotubes and Their Synthesis

- arc discharge deposition large quantities of CNTs but the purity is usually about 30%; not suitable for direct synthesis of supported aligned CNTs
- laser ablation of graphite costly apparatus not amenable for scaleup; small quantities of high-quality SWNTs in 70-90% purity



single-walled nanotube (SWNT)



multi-walled nanotube (MWNT)

CXHV

CxHy

"tip" mode "base" mode

H2

CXHV

O chemical vapor deposition (CVD) supported (energy source)

> plasma enhanced CVD (PECVD)

thermal CVD

reactants: hydrocarbons or CO mixed with H_2 , NH_3 , N_2 ...

floating catalyst: $Fe(C_5H_5)_2$, $Fe(CO)_5$

Chemical Vapor Deposition of CNTs

method for direct synthesis of supported aligned CNTs \Rightarrow widely used in recent years

• thermal CVD versus PECVD:

widely accepted argument for PECVD - the presence of inherent electric field influencing the growth orientation of CNTs



Chhowalla et al., J. Appl. Phys. 90, (2001), 5308

conventional argument ?? - lower process temperature of PECVD

○ low pressure PECVD: d.c. and r.f. glow discharges, microwave discharge, ECR, ...

O atmospheric pressure PECVD: DBD, APG, torches and jets



unique approach - surface bound deposition of CNTs by PECVD in microwave torch

Microwave Torch at Atmospheric Pressure guartz substrate holder for Deposition of CNTs



Surface-Bound Deposition of CNTs in MW Torch

- mw power: 400 W
- > Ar: 1500 sccm
- ≻ H₂: 285-430 sccm
- ≻ CH₄: 25-42 sccm



1500/430/42 sccm 700 °C, 45 s, 15 nm Fe on Si barrier diffusion layer ISN'T NECESSARY!

Fe catalytic layer, 2-20 nm • prepared by vacuum evaporation

SiO₂ like film, 200 nm \cdot PECVD from HMDSO/O₂ in CCP glow discharge annealed 30 min at 700 °C

Si 10x15 mm²

Control of Substrate Temperature

substrate is heated by heat exchange with the gas and surface recombination

gas temperature is controlled by power input, gas mixture, spatial position



400 W, 1500 sccm of Ar, 42 sccm of CH_4



L. Zajíčková et al. Plasma Phys. Control. Fusion 47 (2005) B655

Characterization of Deposited CNTs I.



 $1500/430/42 \text{ sccm of } Ar/H_2/CH_4$

L. Zajíčková et al. Plasma Process. Polymers 4 (2007) S245

Characterization of Deposited CNTs II.



Some Ways to Improve Deposition Uniformity

 \bigcirc pre-heating of the substrate in Ar/H₂ torch



O. Jašek et al. J. Phys. Chem. Solids 68 (2007) 738

O flipping the catalytical active layer outwards the torch The active area for the CNT deposition IS NOT in a direct contact with the torch and the uniformity is influenced only by the gas flow

O larger uniform areas - moveable torch or substrate, multi-torch operation ?

Pressure Sensor Based on Field Emission of CNTs



fabricated using • 525 μm thick Si doped to 0.005 Ωcm • insulating spacer

directly deposited CNTs

anode – silicon membrane etched anisotropically in KOH solution



cathode - emitting CNTs on conductive Si



Simulation of deflection and stresses by ANSYS \Rightarrow area and thickness optimization for 0-500 kPa (shown for 100 kPa)

are of 5 x 5 mm, thickness of 200 μm

Pressure Sensor Based on Field Emission of CNTs



average height of 20 μm



1500/430/42 sccm 700 °C, 30 s - treatm. + 30 s - depos. 15 nm Fe on Si





Heavy Metal Sensor: Electrochemical Detection

electrochemistry is suitable technique for detection of heavy metals but it is necessary to replace Hg electrodes \Rightarrow sensors with solid electrodes prepared by Thick Film Technology (screen-printing),

CNTS

area increase required!





detection of cadmium in KCL by differential pulsed voltammetry

Conclusion

O Microwave torch used for the deposition of CNTs at atmospheric pressure has several pros and <u>cons</u>:

• without requirement of vacuum and heating equipment

 \bigcirc fast process time: catalyst activation is an integral part of the deposition, deposition of 20 μ m long CNTs within 30 s

O problem of reproducibility due to high speed of the process

• problem of non-uniformity

• The process can be applied for the preparation of functional devices such as sensors based on the emissive properties, electrode area increase or perhaps electrical resistance of CNTs.